re Application of:)	PATENT APPLICATION
Inventors:	Wei Pan, Yoshi Ono, David Russell Evans, and Sheng Teng Hsu))))	Attorney Docket No. SLA0515
Serial No.:	09/819,296)	
Filed:	March 27, 2001)	Group Art Unit 2811
Title:	MULTI-LAYERED BARRIER METAL THIN FILMS FOR Cu INTERCONNECT BY ALCVD))	Examiner: Vu, Hung K. Confirmation No.: 4061

Commissioner for Patents P.O. Box 1450 Alexandria, VA 22313-1450

CERTIFICATE OF TRANSMITTAL UNDER 37 C.F.R. §1.8

I hereby certify that this correspondence is being Deposited with the U.S. Postal Service as first class mail Under 37 CFR 1.8 and is addressed to Mail Stop Amendment Commissioner for Patents, P.O. Box 1450, Alexandria, VA 22313-1450,

David C. Ripma, Reg. #27,672

Signature Date: April 13, 2005

RESPONSE TO A NOTICE OF NON-COMPLIANT

AMENDMENT UNDER 37 CFR 1.121

In response to a Notice of Non-Compliant Amendment dated April 7, 2005, in the above identified application, applicant herewith submits:

- \underline{X} A copy of the Notice of Non-Compliant Amendment (1 page); and
- \underline{X} Amendments to all of the claims, which begin at page 3 of this paper.

Remarks begin on page 8 of this paper.